

TA8238K

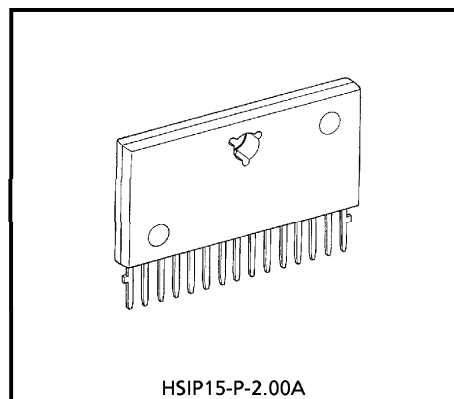
7.3W×2CH AUDIO POWER IC

The TA8238K is dual audio power amplifier for consumer application.

It contains various kind of protectors and the function of stand-by switch.

FEATURES

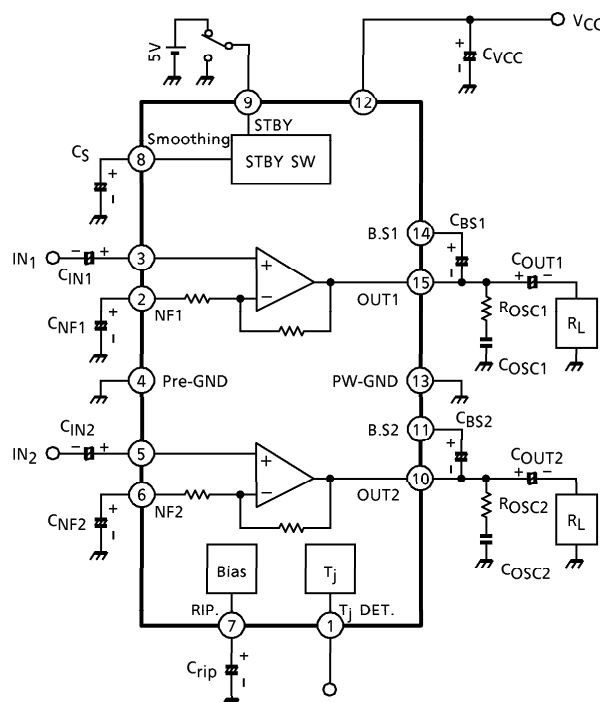
- Output Power
 - : $P_{OUT}(1) = 7.3W$ (Typ.)
($V_{CC} = 13.2V$, $f = 1kHz$, $THD = 10\%$, $R_L = 2\Omega$)
 - : $P_{OUT}(2) = 6.4W$ (Typ.)
($V_{CC} = 14.4V$, $f = 1kHz$, $THD = 10\%$, $R_L = 4\Omega$)
 - : $P_{OUT}(3) = 5.3W$ (Typ.)
($V_{CC} = 13.2V$, $f = 1kHz$, $THD = 10\%$, $R_L = 4\Omega$)
- Total Harmonic Distortion
 - : $THD = 0.1\%$ (Typ.)
($V_{CC} = 13.2V$, $f = 1kHz$, $P_{out} = 1W$, $R_L = 4\Omega$)
- Built In Stand-By Switch Function
 - : $I_{STBY} = 1\mu A$ (Typ.)
(With Pin⑨ set at High, power is turned ON.)
- Built In Junction Temperature Detection Function
(Pin① : $10mV/^{\circ}C$)
- Built In Various Protection Circuits
 - : Over Voltage, Thermal Shut Down
Out to GND, Out to V_{CC}
- Operating Supply Voltage
 - : $V_{CC} (opr.) = 6\sim 18V$



Weight : 3.9g (Typ.)

BLOCK DIAGRAM

($G_V = 52\text{dB}$)



CAUTION AND APPLICATION METHOD

(Description is made only on the single channel.)

1. Voltage Gain Adjustment

The closed loop voltage gain (G_V) is determined by R_1 , R_2 and R_f .

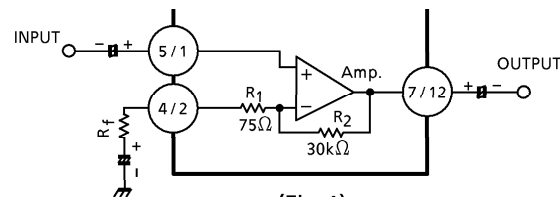
$$G_V = 20 \log \frac{R_f + R_1 + R_2}{R_f + R_1} \text{ (dB)}$$

When $R_f = 0$, $G_V = 52\text{dB}$ (Typ.) is given.

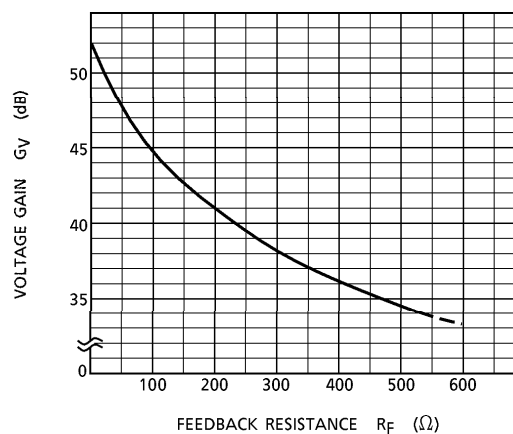
The voltage gain is reduced when R_f is increased.

(Fig.2)

With the voltage gain reduced, since the oscillation stability is reduced, refer to the items 3.



(Fig.1)



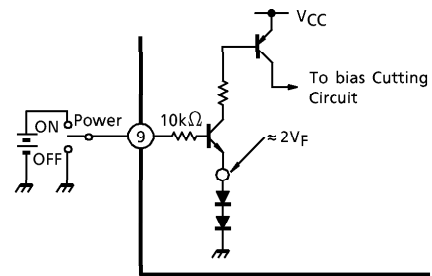
(Fig.2)

2. Stand-by SW Function

By means of controlling pin⑨ (Stand-by terminal) to High and Low, the power supply can be set to ON and OFF. The threshold voltage of pin⑨ is set at 2.1V ($3V_{BE}$), and the Power Supply current is about $1\mu\text{A}$ (Typ.) at the stand-by state.

Control Voltage pin⑨ : V (SB)

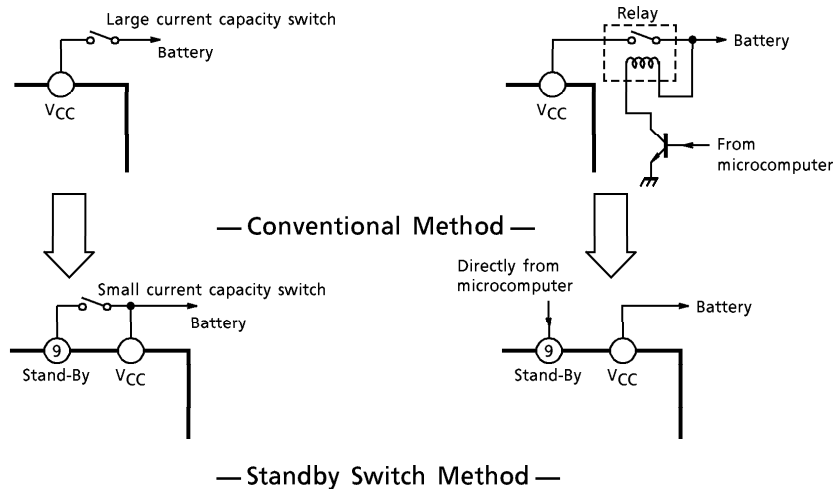
Stand-By	Power	V (SB) (V)
ON	OFF	0~2
OFF	ON	3~ V_{CC}



(Fig.3) With Pin⑨ Set to High, Power is Turned ON.

Advantage of Stand-by SW

- (1) Since V_{CC} can directly be controlled to ON, OFF by the microcomputer, the switching relay can be omitted.
- (2) Since the control current is microscopic, the switching relay of small current capacity is satisfactory for switching.



3. Preventive Measure Against Oscillation

C_{OSC} : For preventing the oscillation, it is advisable to use C_{OSC} , the condenser of polyester film having small characteristic fluctuation of the temperature and the frequency.

The resistance R to be series applied to C_{OSC} is effective for phase correction of high frequency, and improves the oscillation allowance.

- (1) Voltage gain to be used (G_V Setting)
- (2) Capacity value of condenser
- (3) Kind of condenser
- (4) Layout of printed board

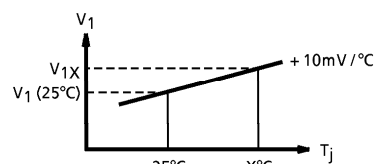
In case of its use with the voltage gain G_V reduced or with the feedback amount increased, care must be taken because the phase-inversion is caused by the high frequency resulting in making the oscillation liable generated.

4. Junction Temperature Detecting pin①

Using temperature characteristic of a band gap circuit and in proportion to junction temperature, pin① DC voltage : V_2 rises at about $+10\text{mV}/^\circ\text{C}$ temperature characteristic. So, the relation between V_2 at $T_j=25^\circ\text{C}$ and V_{2x} at $T_j=x^\circ\text{C}$ is decided by the following expression :

$$T (x^\circ\text{C}) = \frac{V_{2x} - V_2 (25^\circ\text{C})}{10\text{mV}/^\circ\text{C}} + 25 (^\circ\text{C})$$

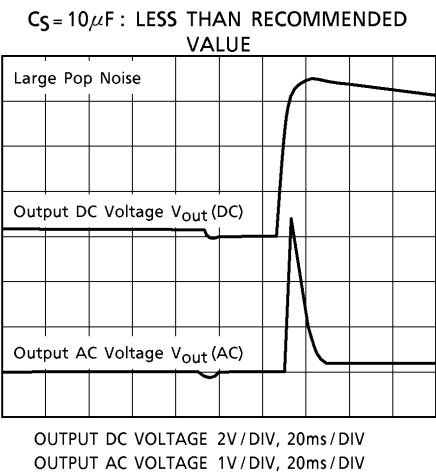
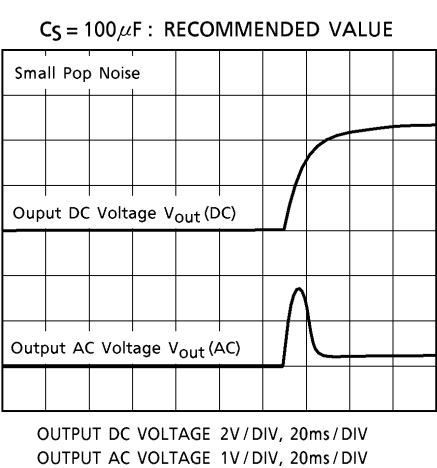
In deciding a heat sink size, a junction temperature can be easily made clear by measuring voltage at this pin while a backside temperature of IC was so far measured using a thermocouple type thermometer.



(Fig.4)

5. Pop Noise

The pop noise is reduced by the time constant τ of pin⑧ : smoothing.
Therefore, we recommend $C_S = 100\mu\text{F}$, which is between pin⑧ and GND, because the pop noise will become worse by using the smaller capacity of C_S .



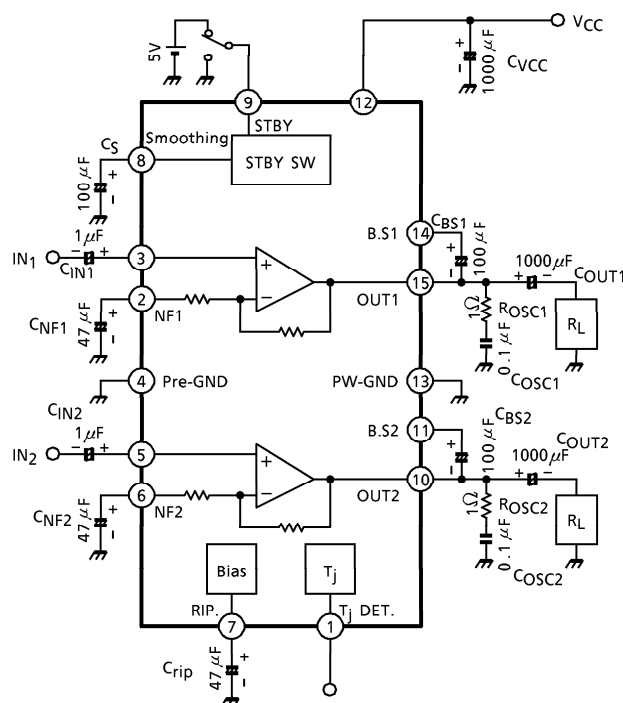
MAXIMUM RATINGS (Ta = 25°C)

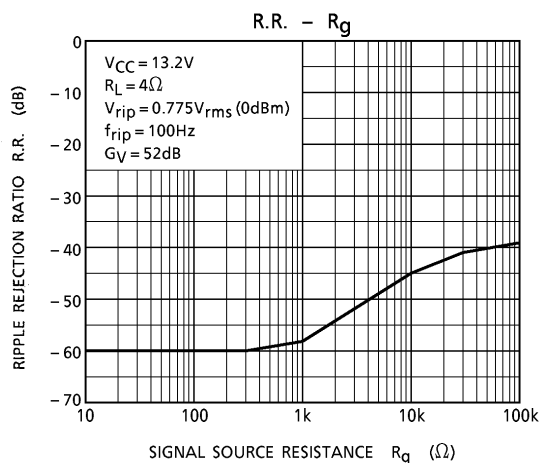
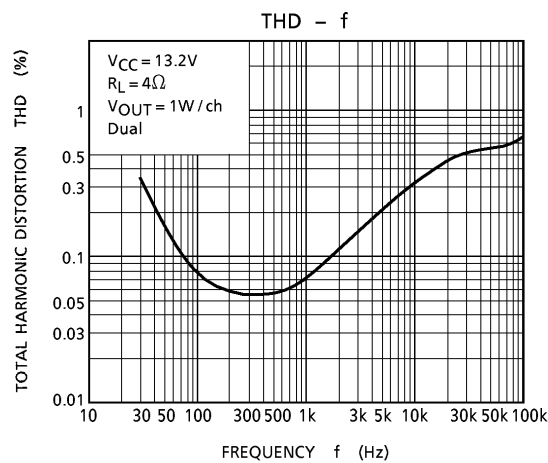
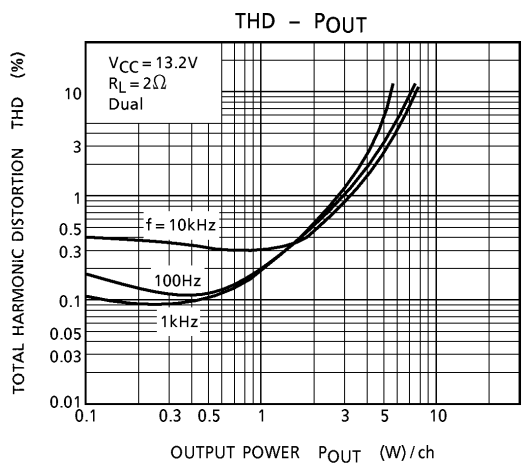
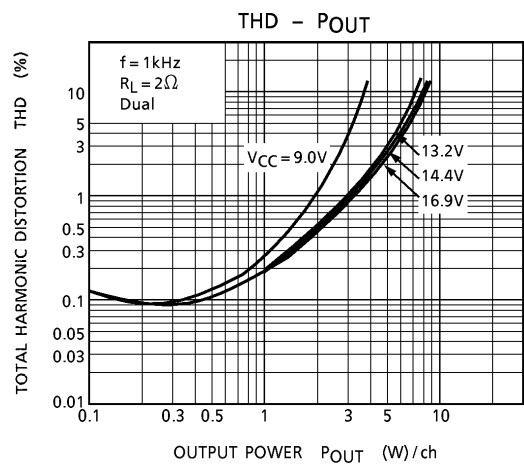
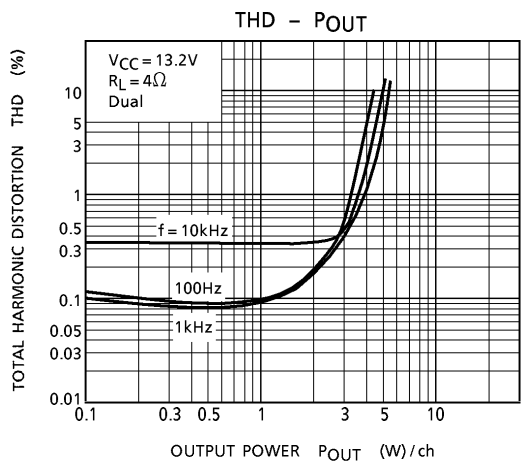
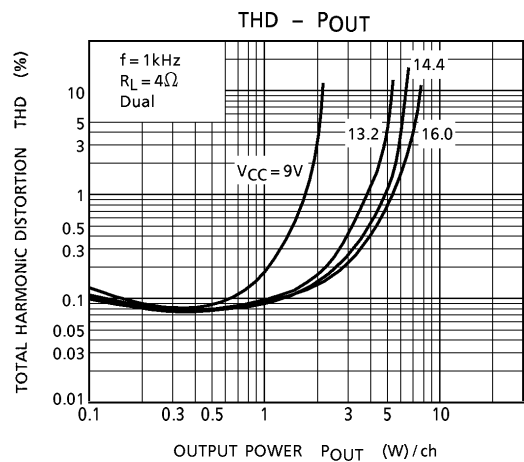
CHARACTERISTIC	SYMBOL	RATING	UNIT
Peak Supply Voltage (0.2s)	$V_{CC}(\text{surge})$	50	V
DC Supply Voltage	$V_{CC}(\text{DC})$	20	V
Operating Supply Voltage	$V_{CC}(\text{opr})$	18	V
Output Current (peak)	$I_O(\text{peak})$	4.5	A
Power Dissipation	P_D	15	W
Operating Temperature	T_{opr}	- 30~85	°C
Storage Temperature	T_{stg}	- 55~150	°C

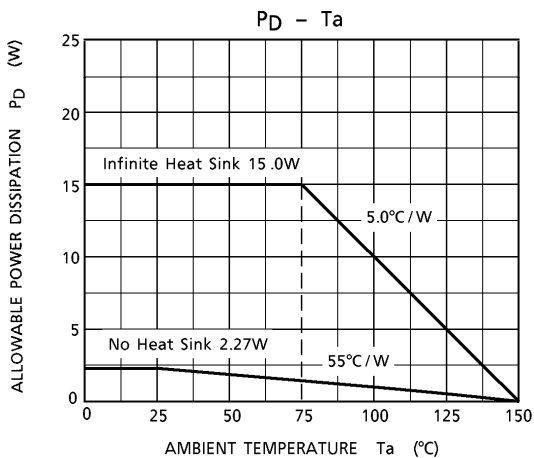
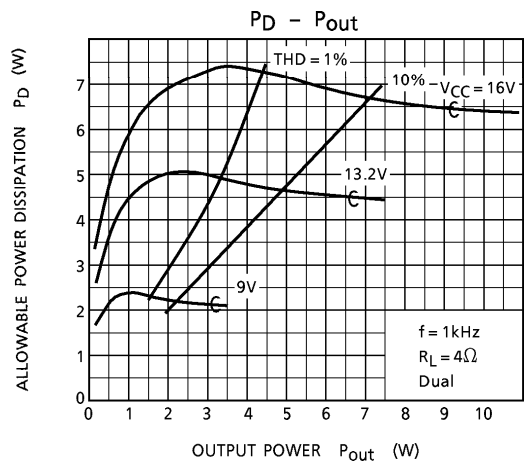
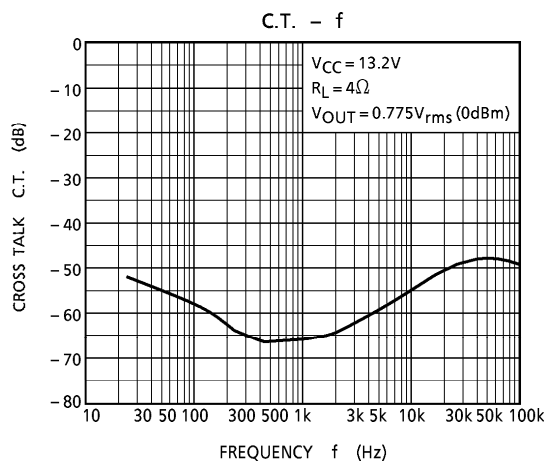
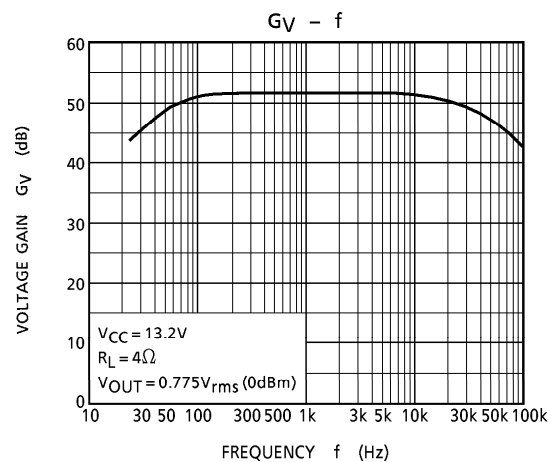
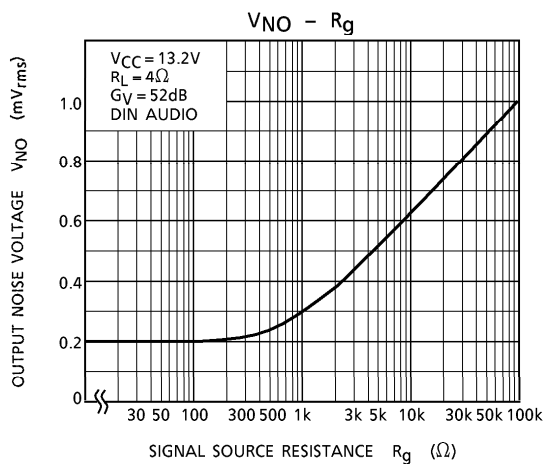
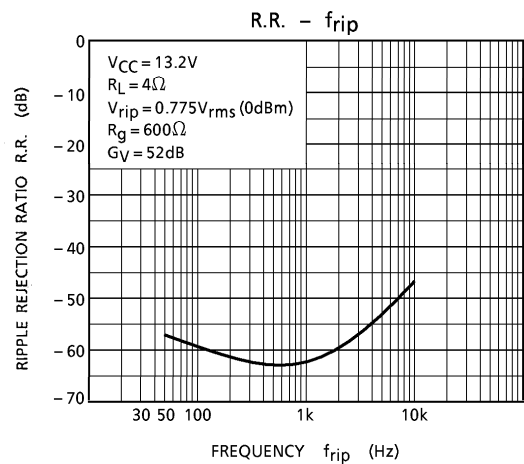
(Unless otherwise specified, $V_{CC} = 13.2V$, $f = 1kHz$, $R_G = 600\Omega$, $R_L = 4\Omega$, $T_a = 25^\circ C$)

CHARACTERISTIC	SYMBOL	TEST CIR- CUIT	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Quiescent Current	I _{ccq}	—	V _{in} = 0	—	60	150	mA
Output Power	P _{out} (1)	—	THD = 10%, R _L = 2Ω	—	7.3	—	W
	P _{out} (2)	—	V _{CC} = 14.4V, THD = 10%	—	6.4	—	W
	P _{out} (3)	—	THD = 10%	4.8	5.3	—	W
Total Harmonic Distortion	THD	—	P _{out} = 1W	—	0.1	0.5	%
Voltage Gain	G _V	—	V _{out} = 0.775V _{rms} (0dBm)	50	52	54	dB
Voltage Gain Ratio	ΔG _V	—	V _{out} = 0.775V _{rms} (0dBm)	- 1	0	1	dB
Output Noise Voltage	V _{NO}	—	R _g = 0Ω, BW = 20Hz~20kHz	—	0.2	0.7	mV _{rms}
Ripple Rejection Ratio	R.R.	—	f _{ripple} = 100Hz, V _{out} = 0.775V _{rms} (0dBm) , R _g = 600Ω	40	57	—	dB
Cross Talk	C.T.	—	R _g = 600Ω, V _{out} = 0.775V _{rms} (0dBm)	—	65	—	dB
Input Resistance	R _{IN}	—	—	—	30	—	kΩ
Stand-By Current	I _{STBY}	—	Pin⑨ : GND	—	1	10	μA

($G_V = 52\text{dB}$)

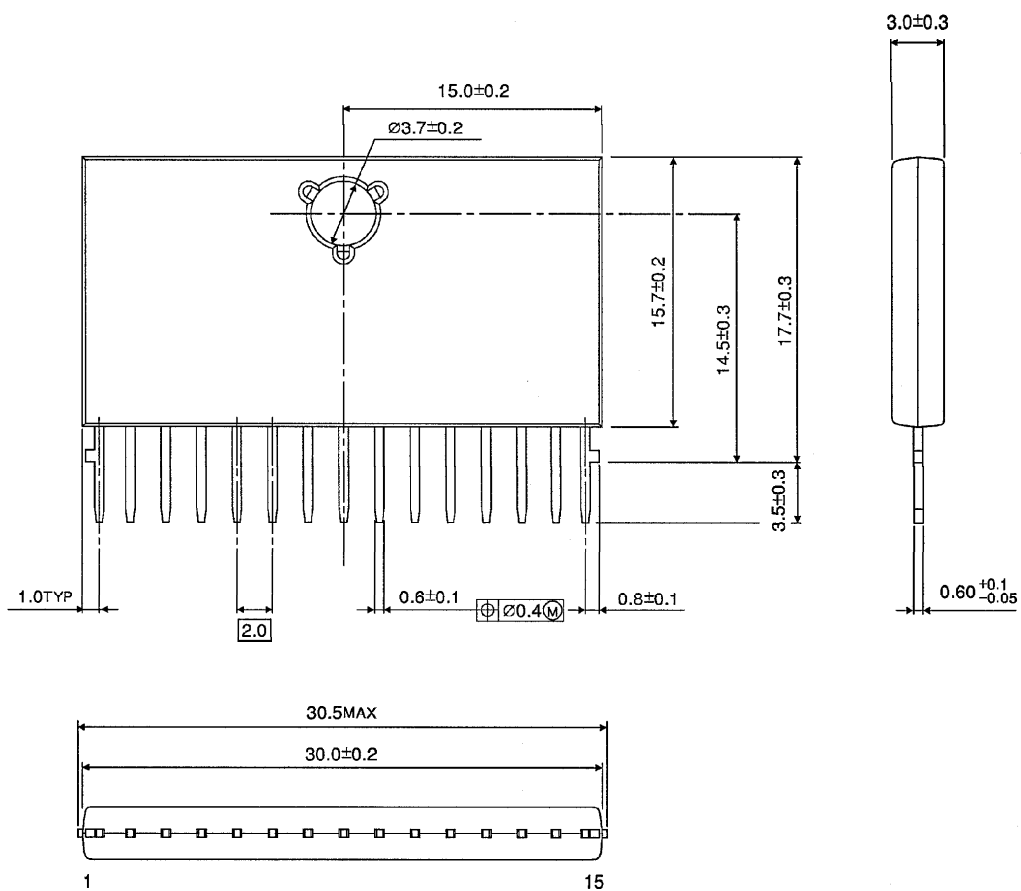






PACKAGE DIMENSIONS
HSIP15-P-2.00A

Unit : mm



Weight : 3.9g (Typ.)

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